Product data sheet

1. Product profile

1.1 General description

High-voltage, high-speed planar-passivated NPN power switching transistor in a SOT428 (D-PAK) surface mounted package.

1.2 Features and benefits

Low thermal resistance

Fast switching

1.3 Applications

- Electronic lighting ballasts
- Inverters

- DC-to-DC converters
- Motor control systems

1.4 Quick reference data

- V_{CESM} ≤ 700 V
- Arr P_{tot} \leq 80 W

- $I_C \le 4 A$
- h_{FEsat} = 12.5 (typ)

2. Pinning information

Table 1. Pinning

	3			
Pin	Description	Simplified outline	Symbol	
1	base	mb	С	
2	collector	[1]	J	
3	emitter		В	
mb	mounting base; connected to collector		 E sym123	
		SOT428 (D-PAK)		

^[1] It is not possible to make a connection to pin 2 of the SOT428 (D-PAK) package.

3. Ordering information

Table 2. Ordering information

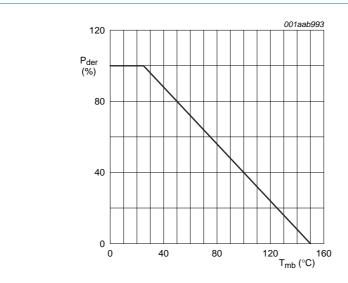
Type number	Package			
	Name	Description	Version	
BUJ103AD	D-PAK	plastic single-ended surface mounted package; 3 leads (one lead cropped)	SOT428	

4. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CESM}	peak collector-emitter voltage	$V_{BE} = 0 V$	-	700	V
V_{CBO}	collector-base voltage	open emitter	-	700	V
V_{CEO}	collector-emitter voltage	open base	-	400	V
I _C	collector current (DC)		-	4	Α
I _{CM}	peak collector current		-	8	Α
I_{B}	base current (DC)		-	2	Α
I_{BM}	peak base current		-	4	Α
P _{tot}	total power dissipation	$T_{mb} \le 25$ °C; see Figure 1	-	80	W
T _{stg}	storage temperature		-65	+150	°C
T _j	junction temperature		-	150	°C



$$P_{der}(\%) = \frac{P_{tot}}{P_{tot(25 °C)}} \times 100\%$$

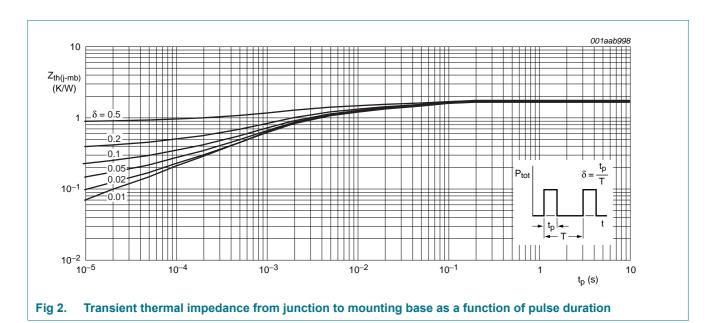
Fig 1. Normalized total power dissipation as a function of mounting base temperature

5. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 2	-	-	1.56	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient		<u>[1]</u> _	75	-	K/W

[1] Device mounted on a printed-circuit board; minimum footprint.



6. Characteristics

Table 5. Characteristics

 T_{mb} = 25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	acteristics					
I _{CES}	collector-emitter cut-off	V _{BE} = 0 V; V _{CE} = V _{CESMmax}	<u>[1]</u> _	-	1.0	mA
	current	$V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax}; T_j = 125 ^{\circ}\text{C}$	<u>[1]</u> _	-	2.0	mA
I _{CBO}	collector-base cut-off current	V _{BE} = 0 V; V _{CE} = V _{CESMmax}	<u>[1]</u> _	-	1.0	mΑ
I _{CEO}	collector-emitter cut-off current	$V_{CEO} = V_{CEOMmax} = 400 \text{ V}$	<u>[1]</u> _	-	0.1	mA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 7 \text{ V}; I_{C} = 0 \text{ A}$	-	-	0.1	mA
V _{CEOsus}	collector-emitter sustaining voltage	$I_B = 0$ A; $I_C = 10$ mA; L = 25 mH; see Figure 3 and 4	400	-	-	V
V _{CEsat}	collector-emitter saturation voltage	$I_C = 3.0 \text{ A}$; $I_B = 0.6 \text{ A}$; see Figure 10	-	0.25	1.0	V
V_{BEsat}	base-emitter saturation voltage	$I_C = 3.0 \text{ A}$; $I_B = 0.6 \text{ A}$; see <u>Figure 11</u>	-	0.97	1.5	V
h _{FE}	DC current gain	$I_C = 1 \text{ mA}$; $V_{CE} = 5 \text{ V}$; see <u>Figure 9</u>	10	17	32	
		$I_C = 500 \text{ mA}; V_{CE} = 5 \text{ V}$	13	22	32	

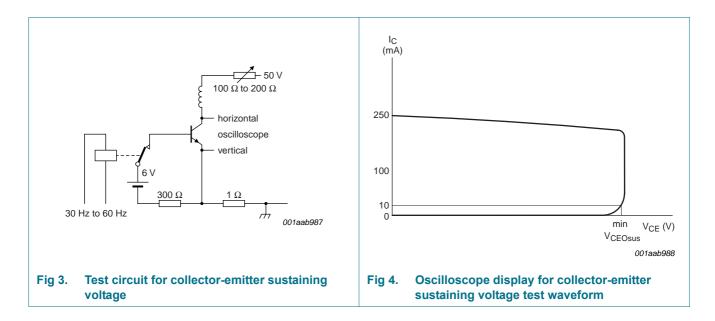
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 Table 5.
 Characteristics ...continued

 $T_{mb} = 25$ °C; unless otherwise specified.

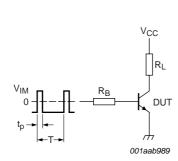
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
h _{FEsat}	DC saturation current gain	$I_C = 2.0 \text{ A}; V_{CE} = 5 \text{ V}$	11	16	22	
		$I_C = 3.0 \text{ A}; V_{CE} = 5 \text{ V}$	-	12.5	-	
Dynamic o	characteristics					
Switching t	imes (resistive load); see Figure	<u>5</u> and <u>6</u>				
t _{on}	turn-on time	I_{Con} = 2.5 A; I_{Bon} = $-I_{Boff}$ = 0.5 A; R_L = 75 Ω	-	0.52	0.6	μS
t _{stg}	storage time		-	2.7	3.3	μS
t _f	fall time		-	0.3	0.35	μS
Switching t	imes (inductive load); see Figure	<u>e 7</u> and <u>8</u>				
t _{stg}	storage time	$I_{Con} = 2 \text{ A}; I_{Bon} = 0.4 \text{ A}; L_{B} = 1 \mu\text{H};$ $V_{BB} = -5 \text{ V}$	-	1.2	1.4	μS
t _f	fall time		-	30	60	ns
Switching t	imes (inductive load); see Figure	<u>e 7</u> and <u>8</u>				
t _{stg}	storage time	I_{Con} = 2 A; I_{Bon} = 0.4 A; L_{B} = 1 μ H; V_{BB} = -5 V; T_{j} = 100 °C	-	-	1.8	μS
t _f	fall time		-	-	120	ns

[1] Measured with half sine-wave voltage (curve tracer).



 $\mathsf{I}_{\mathsf{Con}}$

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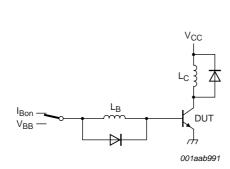
 V_{IM} = -6 V to +8 V; V_{CC} = 250 V; t_p = 20 $\mu s;$ δ = t_p/T = 0.01.

 R_{B} and R_{L} calculated from I_{Con} and I_{Bon} requirements.

10% $t_{r} \leq 30 \text{ ns}$ $t_{r} \leq 30 \text{ ns}$ $t_{r} \leq 30 \text{ ns}$ $t_{r} \leq 30 \text{ ns}$

Fig 6. Switching times waveforms for resistive load

Fig 5. Test circuit for resistive load switching



 V_{CC} = 300 V; V_{BB} = –5 V; L_{C} = 200 $\mu H; \ L_{B}$ = 1 $\mu H.$

Fig 7. Test circuit for inductive load switching

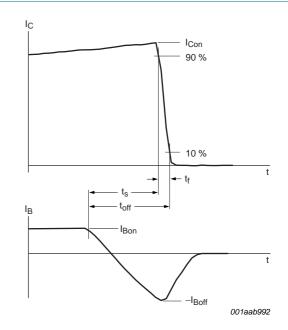


Fig 8. Switching times waveforms for inductive load

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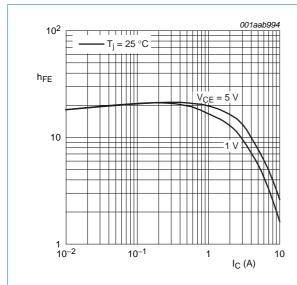


Fig 9. DC current gain as a function of collector current; typical values

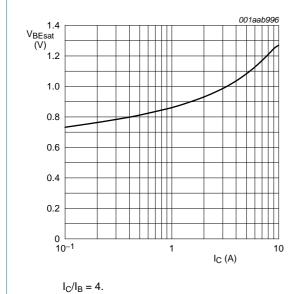
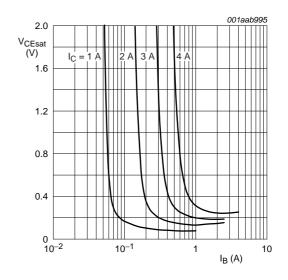
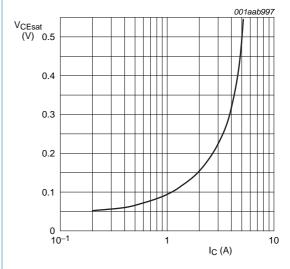


Fig 11. Base-emitter saturation voltage as a function of collector current; typical values



 $T_i = 25 \, ^{\circ}C$.

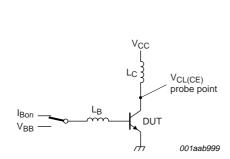
Fig 10. Collector-emitter saturation voltage as a function of base current; typical values



 $I_{\rm C}/I_{\rm B}=4$.

Fig 12. Collector-emitter saturation voltage as a function of collector current; typical values

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 $V_{CEclamp} \leq 1000 \ V; \ V_{CC} = 150 \ V; \ V_{BB} = -5 \ V; \ L_B = 1 \ \mu H;$

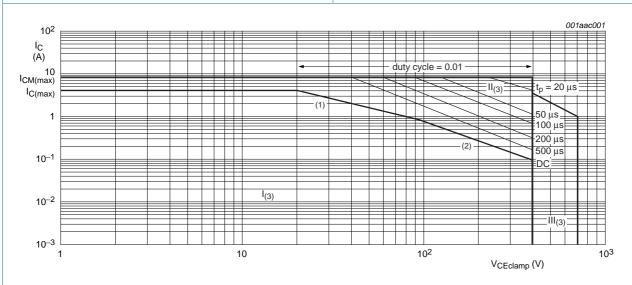
 $L_C = 200 \ \mu H.$

001aac000 10 I_C 8 6 4 2 0 200 1000 V_{CEclamp} (V)

 $T_j \leq T_{j(max)}.$

Fig 14. Reverse bias safe operating area





 T_{mb} \leq 25 °C; Mounted with heatsink compound and 30 \pm 5 Newton force on the center of the envelope.

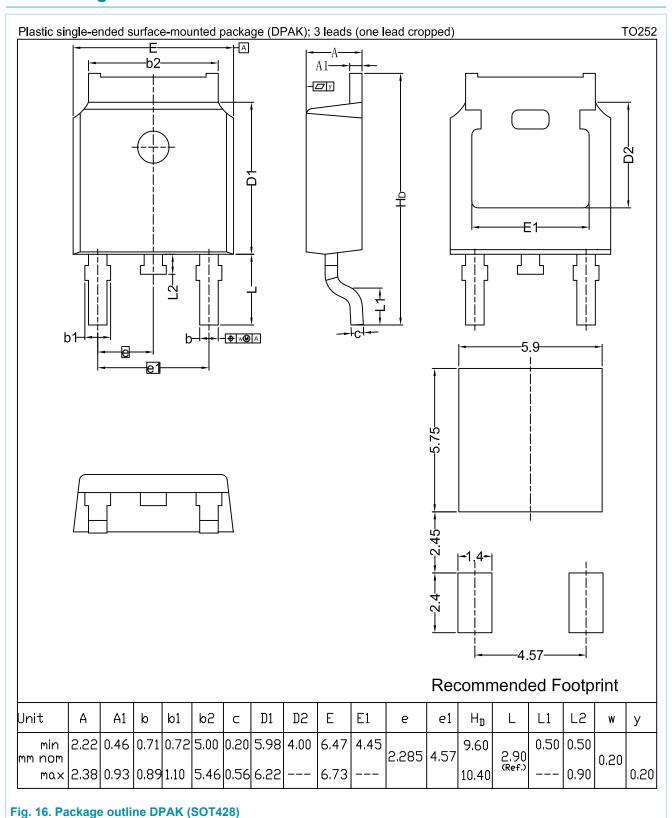
- (1) Ptot maximum and Ptot peak maximum lines.
- (2) Second breakdown limits.
- (3) I = Region of permissible DC operation.
 - II = Extension for repetitive pulse operation.
 - III = Extension during turn-on in single transistor converters provided that $R_{BE} \le 100~\Omega$ and $t_p \le 0.6~\mu s$.

Fig 15. Forward bias safe operating area

Package information 7.

Epoxy meets requirements of UL94 V-0 at ½ inch.

8. Package outline



WeEn Semiconductors

BUJ103AD

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9. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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